

# APPROVAL SHEET

PCB ANTENNA

**RoHS Compliance**

2.4 GHz ISM Band Working Frequency

\*Contents in this sheet are subject to change without prior notice.

## Approval sheet

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### FEATURES

1. High stability in Temperature / Humidity Change

### APPLICATIONS

1. 2.4GHz ISM band RF applications
2. Bluetooth, Wireless, HomeRF

### CONSTRUCTION

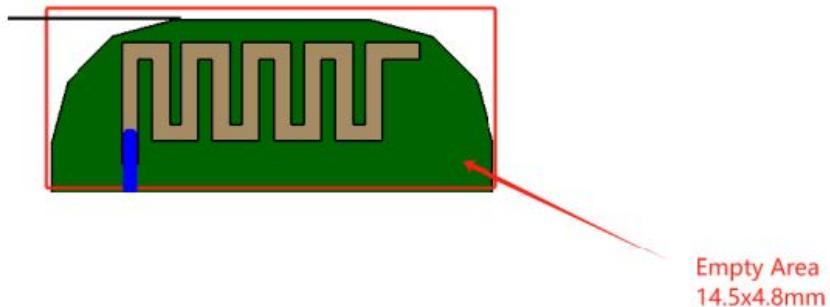


ELECTRICAL CHARACTERISTICS

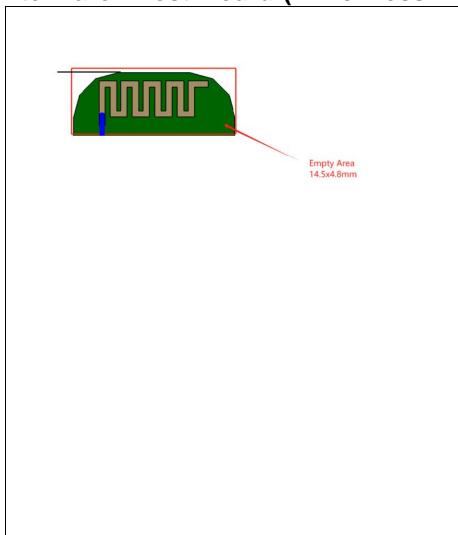
	Specification
Working Frequency Range	2450 ± 50 MHz
F <sub>c</sub> (GHz)	2.9
Gain (dBi)	2.12dBi
VSWR	2 max.
Operation Temperature	-40°C ~ +85°C

SOLDER LAND PATTERN DESIGN

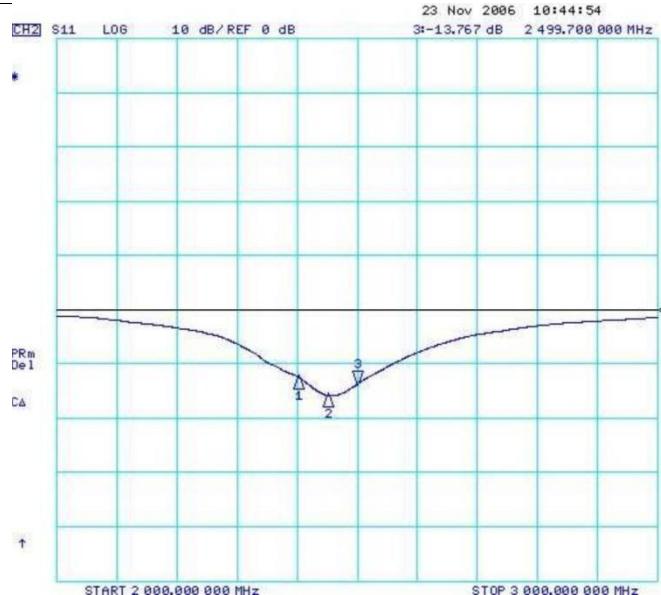
Figure



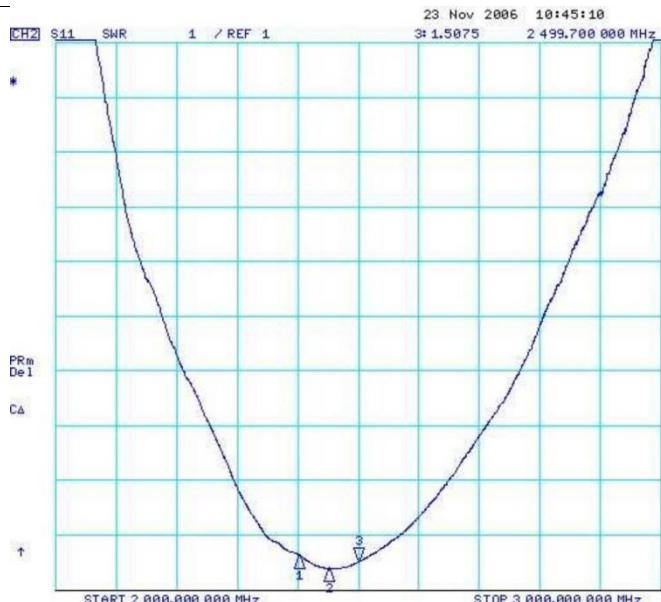
Antenna on Test Board ( Thickness 1.0m)



Antenna S11 on Test Board

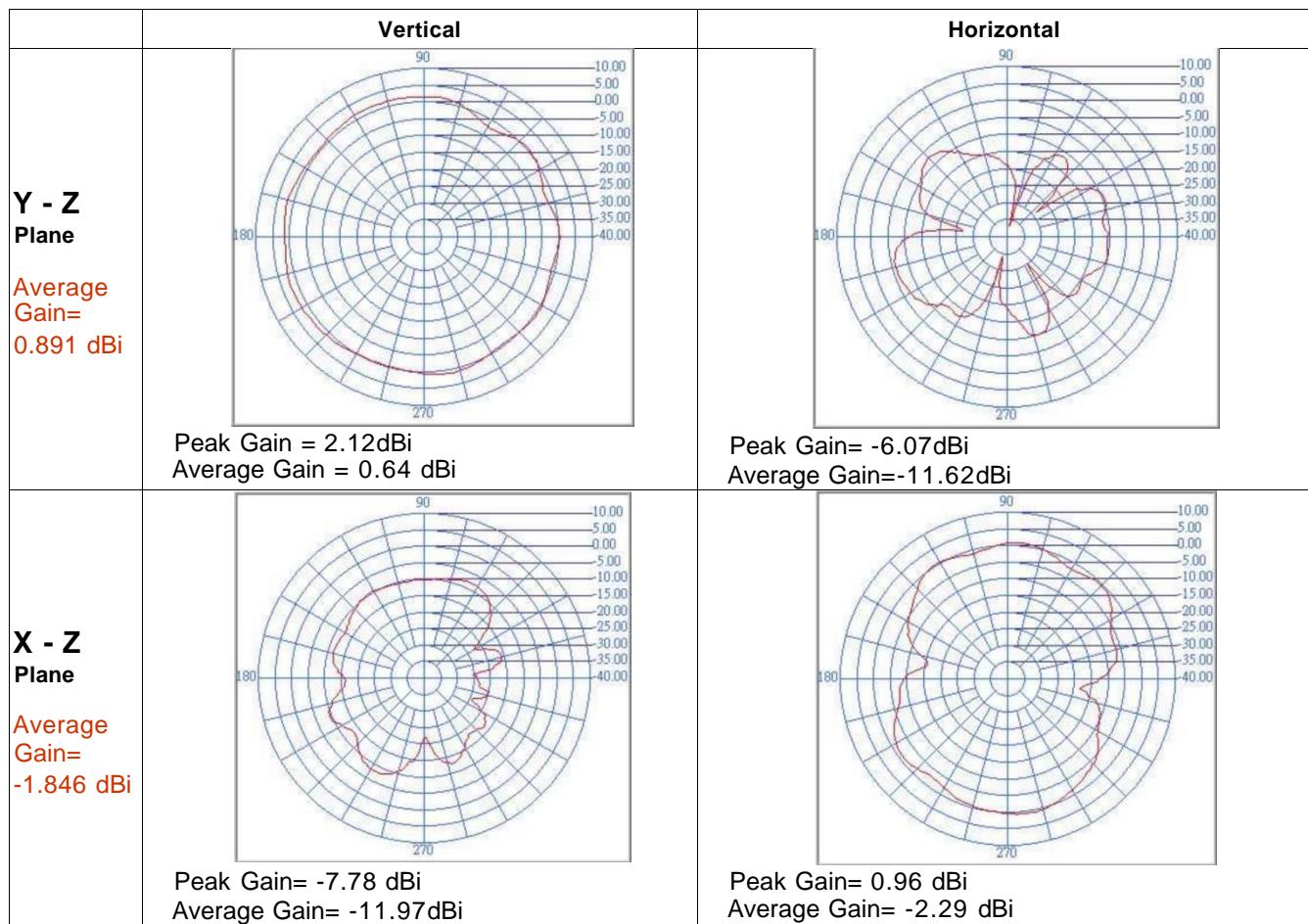
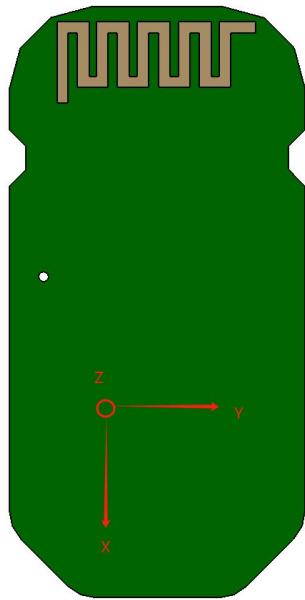


Antenna VSWR on Test Board

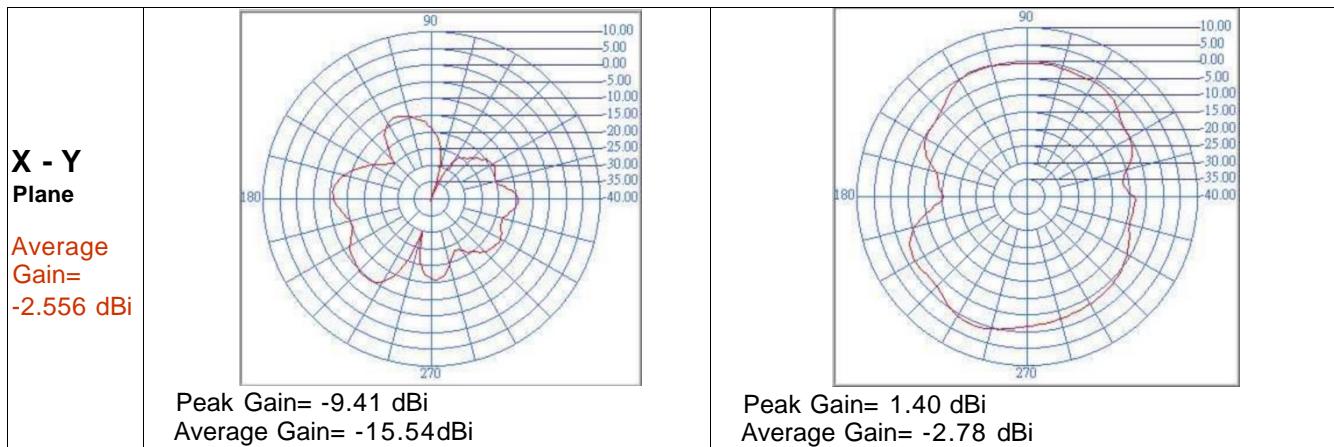


**RADIATION PATTERN**

Radiation Pattern and Gain were dependent on measurement board design. The specification of antenna was measured based on the PCB size and installation position as shown in the below figure Test Board



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**RELIABILITY TEST**

<b>Test item</b>	<b>Test condition / Test method</b>	<b>Specification</b>
Solderability JIS C 0050-4.6 JESD22-B102D	*Solder bath temperature : $235 \pm 5$ °C  *Immersion time : $2 \pm 0.5$ sec  *Solder : Sn3Ag0.5Cu for lead-free	At least 95% of a surface of each terminal electrode must be covered by fresh solder.
Leaching (Resistance to dissolution of metallization) IEC 60068-2-58	*Solder bath temperature : $260 \pm 5$ °C  *Leaching immersion time : $30 \pm 0.5$ sec  *Solder : SN63A	Loss of metallization on the edges of each electrode shall not exceed 25%.
Resistance to soldering heat JIS C 0050-5.4	*Preheating temperature : $120\sim150$ °C , 1 minute.  *Solder temperature : $270 \pm 5$ °C  *Immersion time : $10 \pm 1$ sec  *Solder : Sn3Ag0.5Cu for lead-free  Measurement to be made after keeping at room temperature for $24 \pm 2$ hrs	No mechanical damage.  Samples shall satisfy electrical specification after test.  Loss of metallization on the edges of each electrode shall not exceed 25%.
Drop Test JIS C 0044	*Height : 75 cm  *Test Surface : Rigid surface of concrete or steel.  *Times : 6 surfaces for each units ; 2 times for each side.	No mechanical damage.  Samples shall satisfy electrical specification after test.
Adhesive Strength of Termination JIS C 0051- 7.4.3	*Pressurizing force : 5N( $\leq$ 0603) ; 10N( $>$ 0603)  *Test time : $10 \pm 1$ sec	No remarkable damage or removal of the termination.
Bending test JIS C 0051- 7.4.1	The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second until the deflection becomes 1mm/s and then pressure shall be maintained for $5 \pm 1$ sec.  Measurement to be made after keeping at room temperature for $24 \pm 2$ hours	No mechanical damage.  Samples shall satisfy electrical specification after test.

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Temperature cycle JIS C 0025	1. 30±3 minutes at -40. C±3. C, 2. 10~15 minutes at room temperature, 3. 30±3 minutes at +85. C±3. C, 4. 10~15 minutes at room temperature, Total 100 continuous cycles Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Samples shall satisfy electrical specification after test.
Vibration JIS C 0040	*Frequency : 10Hz~55Hz~10Hz(1min) *Total amplitude : 1.5mm *Test times : 6hrs.(Two hrs each in three mutually perpendicular directions)	No mechanical damage. Samples shall satisfy electrical specification after test.
High temperature JIS C 0021	*Temperature : 85. C±2. C *Test duration : 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Samples shall satisfy electrical specification after test.
Humidity (steady conditions) JIS C 0022	*Humidity : 90% to 95% R.H. *Temperature : 40±2. C *Time : 1000+24/-0 hrs.  Measurement to be made after keeping at room temperature for 24±2 hrs  ※ 500hrs measuring the first data then 1000hrs data	No mechanical damage. Samples shall satisfy electrical specification after test.
Low temperature JIS C 0020	*Temperature : -40. C±2. C *Test duration : 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hrs	No mechanical damage. Samples shall satisfy electrical specification after test.

## SOLDERING CONDITION

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2

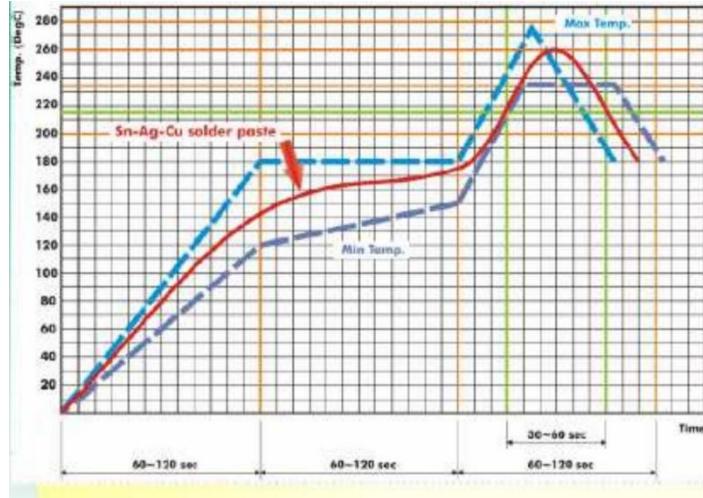


Fig 2. Infrared soldering profile

## CAUTION OF HANDLING

### Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

### Storage condition

- (1) Products should be used in 6 months from the day of WALSIN outgoing inspection, which can be confirmed.
- (2) Storage environment condition.
  - Products should be storage in the warehouse on the following conditions.
  - Temperature : -10 to +40°C
  - Humidity : 30 to 70% relative humidity
  - Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
  - Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
  - Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
  - Products should be storage under the airtight packaged condition.

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**Approval sheet**

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Any changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation.

If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

The device has been evaluated to meet general RF exposure requirement. The device can be used in portable exposure condition without restriction.